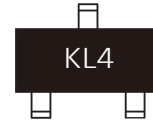


FEATURES

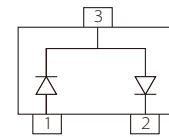
- | High Current Capability
- | Low Forward Voltage Drop
- | Extremely Fast Switching Speed



SOT-23



Marking



Schematic Symbol

MECHANICAL DATA

- | SOT-23 Small Outline Plastic Package
- | Epoxy UL: 94V-0
- | Mounting Position: Any

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS (T_A=25°C)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V _{RRM}	30	V
Maximum RMS voltage	V _{RMS}	21	V
Maximum DC blocking voltage	V _{DC}	30	V
Maximum average forward rectified current	I _{FM}	200	mA
Peak forward surge current 8.3 ms single half sine-wave	I _{FSM}	600	mA
Typical thermal resistance	R _{θJA}	500	°C/W
Power Dissipation	P _D	200	mW
Junction Temperature	T _J	125	°C
Storage temperature range	T _{stg}	-50~+150	°C

ELECTRICAL CHARACTERISTICS($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Forward voltage	V_F	$I_F=0.1\text{mA}$			0.24	V
		$I_F=1.0\text{mA}$			0.32	V
		$I_F=10\text{mA}$			0.40	V
		$I_F=30\text{mA}$			0.50	V
		$I_F=100\text{mA}$			1.00	V
Reverse breakdown voltage	$V_{(BR)}$	$I_R=100\mu\text{A}$	30			V
Reverse Leakage Current	I_R	$V_R=25\text{V}$			2	μA
Type junction capacitance	C_J	$V_R=1\text{V}, f=1\text{MHz}$			10	pF
Reverse Recovery Time	T_{RR}	$I_F=I_R=10\text{mA}, R_L=100\Omega$ $I_{RR}=0.1 \times I_R$			5	nS

CHARACTERISTIC CURVES

Fig.1 Forward Characteristics

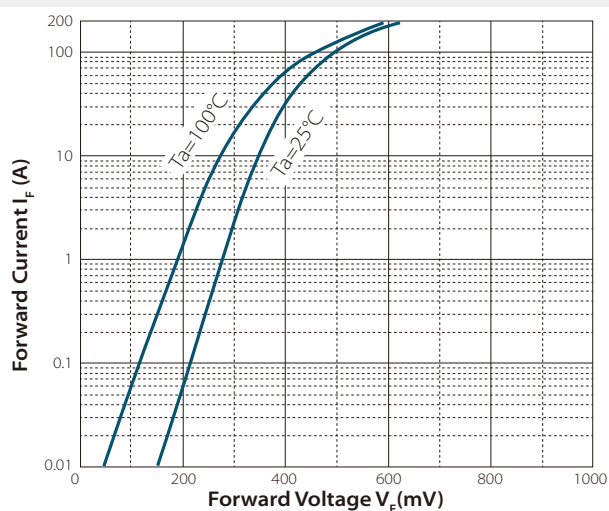


Fig.2 Reverse Characteristics

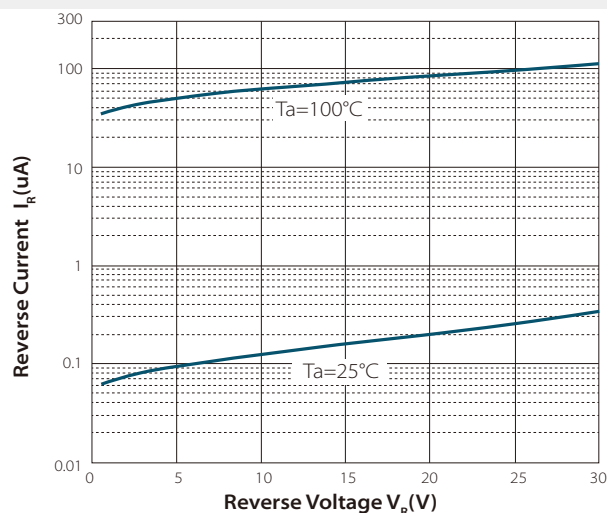
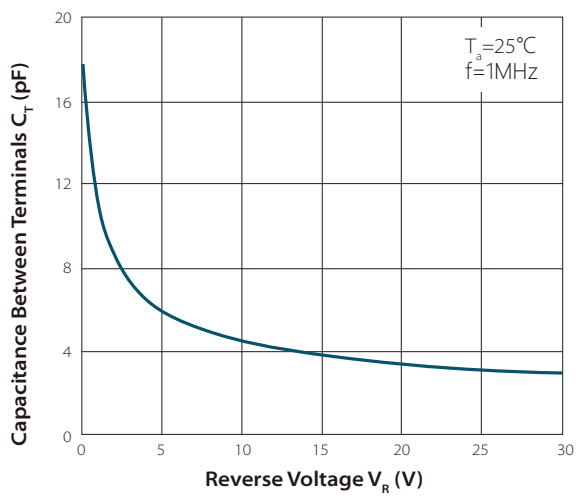
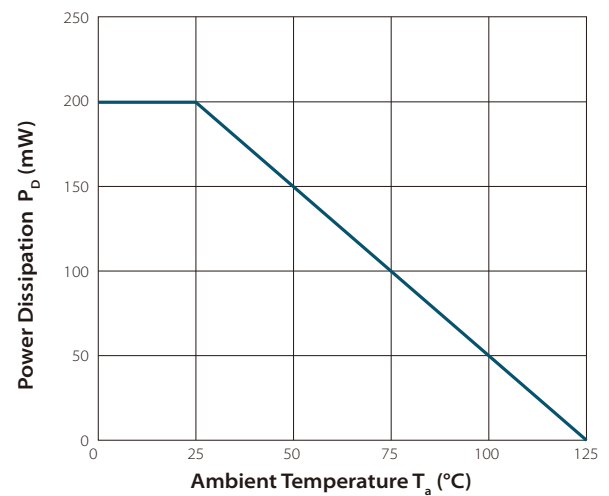
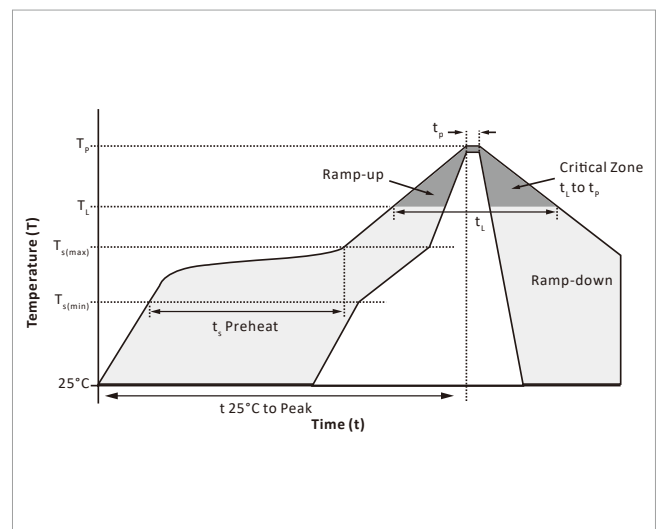


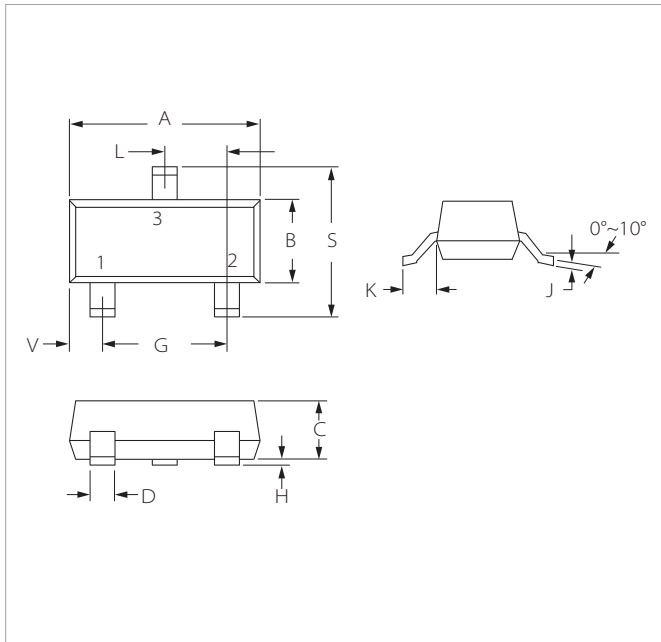
Fig.3 Capacitance Characteristics

Fig.4 Power Derating Curve


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(\min)}$)	150 $^\circ\text{C}$
	Temperature Max ($T_{s(\max)}$)	200 $^\circ\text{C}$
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3 $^\circ\text{C}/\text{second}$ max
$T_{s(\max)}$ to T_L - Ramp-up Rate		3 $^\circ\text{C}/\text{second}$ max
Reflow	Temperature (T_L) (Liquidus)	217 $^\circ\text{C}$
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 $^\circ\text{C}$
Time within 5 $^\circ\text{C}$ of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6 $^\circ\text{C}/\text{second}$ max
Time 25 $^\circ\text{C}$ to peak Temperature (T_p)		8 minutes max.
Do not exceed		260 $^\circ\text{C}$

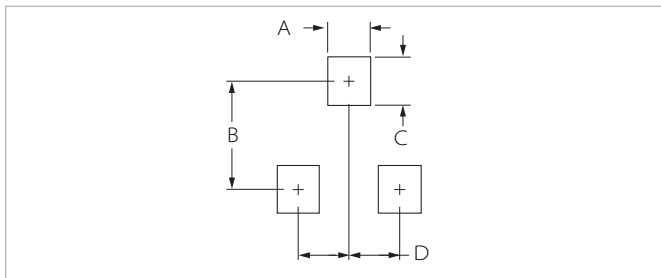


SOT-23 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.80	3.04	0.110	0.120
B	1.20	1.40	0.047	0.055
C	0.89	1.11	0.035	0.044
D	0.37	0.50	0.015	0.020
G	1.78	2.04	0.070	0.081
H	0.01	0.100	0.001	0.004
J	0.085	0.180	0.003	0.007
K	0.35	0.69	0.014	0.029
L	0.89	1.02	0.035	0.040
S	2.10	2.64	0.083	0.104
V	0.45	0.60	0.018	0.024

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.71	0.97	0.028	0.038
B	1.88	2.13	0.074	0.084
C	0.71	0.97	0.028	0.038
D	0.81	1.07	0.032	0.042

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
BAT54S	SOT-23	3000PCS	7"

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